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Product Summary

V_R (V)	I_F (A)	$V_{F\ MAX}$ (V) @ +25°C	$I_{R\ MAX}$ (mA) @ +25°C
60	1.0	0.64	0.05

Description and Applications

This Schottky Barrier Rectifier has been designed to meet the stringent requirements of Automotive Applications. It is ideally suited to use as :

- Polarity Protection Diode
- Re-circulating Diode
- Switching Diode

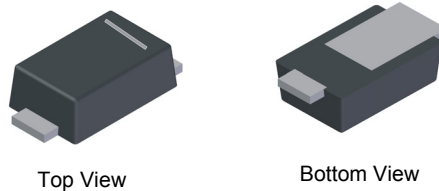
Features and Benefits

- Guard Ring Die Construction for Transient Protection
- High Surge Capability
- Ultra-Small Surface Mount Package
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP Capable (Note 4)**

Mechanical Data

- Case: POWERDI323
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Polarity: Cathode Band
- Terminals: Finish - Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 [Ⓔ]
- Weight: 0.006 grams (approximate)

POWERDI323



Top View

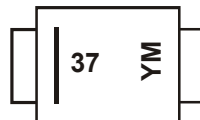
Bottom View

Ordering Information (Note 5)

Part Number	Compliance	Case	Packaging
PD3S160Q-7	Automotive	POWERDI323	3000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.
 5. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



37 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: T = 2014)
 M = Month (ex: 9 = September)

Date Code Key

Year	2014	2015	2016	2017	2018	2019	2020	2021	2022	2023	2024	2025
Code	B	C	D	E	F	G	H	I	J	K	L	M
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	60	V
RMS Reverse Voltage	$V_{R(RMS)}$	42	V
Average Forward Current (See also figure 4)	$I_{F(AV)}$	1.0	A
Repetitive Peak Forward Current $t_p \leq 1\text{ms}$; $\delta \leq 0.25$	I_{FRM}	8	A
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	22	A

Thermal Characteristics

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance Junction to Soldering Point	$R_{\theta JS}$	—	6	$^\circ\text{C/W}$
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{\theta JA}$	173	—	$^\circ\text{C/W}$
Thermal Resistance Junction to Ambient Air (Note 7)	$R_{\theta JA}$	125	—	$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150		$^\circ\text{C}$

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 8)	$V_{(BR)R}$	60	—	—	V	$I_R = 100\mu\text{A}$
Forward Voltage	V_F	—	0.40 0.55 —	0.45 0.58 0.64	V	$I_F = 0.1\text{A}$ $I_F = 0.7\text{A}$ $I_F = 1.0\text{A}$
Leakage Current (Note 8)	I_R	—	0.3 3	5 50	μA	$V_R = 5\text{V}, T_A = +25^\circ\text{C}$ $V_R = 60\text{V}, T_A = +25^\circ\text{C}$
Total Capacitance (See also figure 3)	C_T	—	38	—	pF	$V_R = 10\text{V}, f = 1.0\text{MHz}$

Notes: 6. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com>. $T_A = +25^\circ\text{C}$.
7. Polyimide PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com>. $T_A = +25^\circ\text{C}$.
8. Short duration pulse test used to minimize self-heating effect.

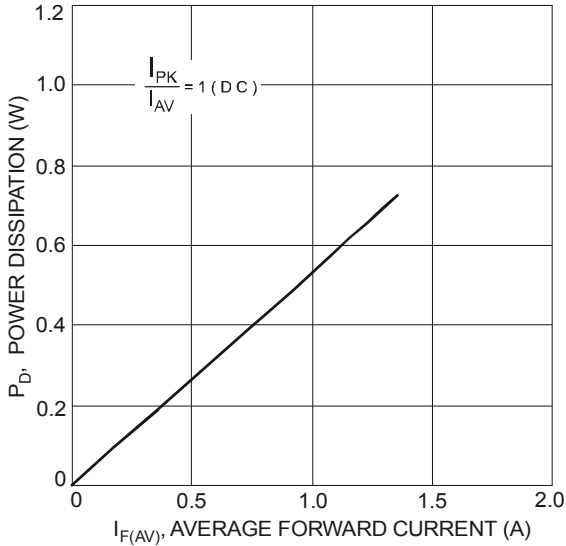


Figure 1 Forward Power Dissipation

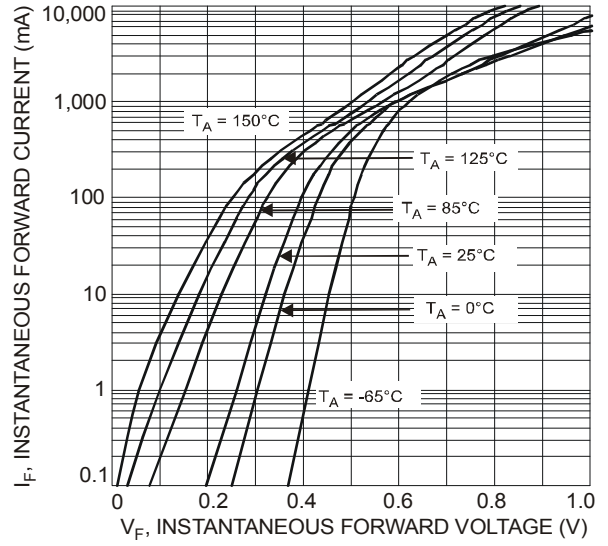


Figure 2 Typical Forward Characteristics

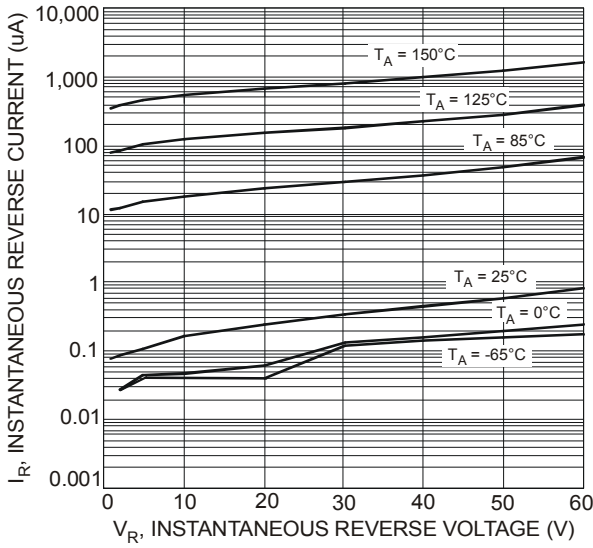


Figure 3 Typical Reverse Characteristics

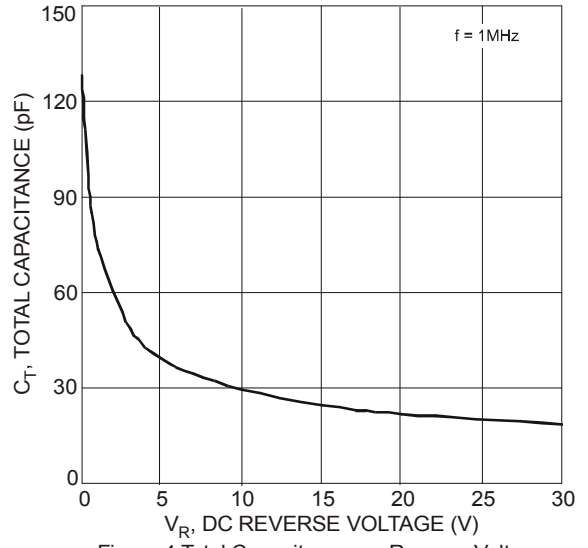


Figure 4 Total Capacitance vs. Reverse Voltage

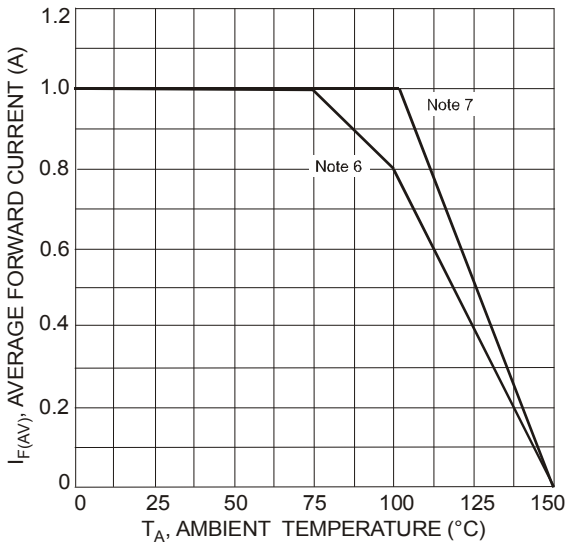


Figure 5 Forward Current Derating Curve

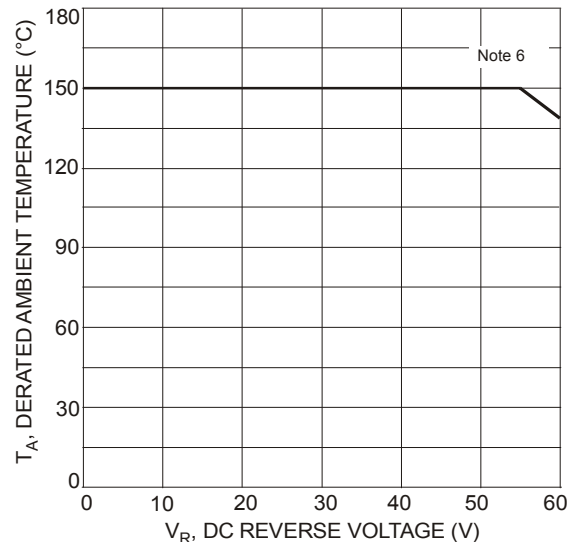
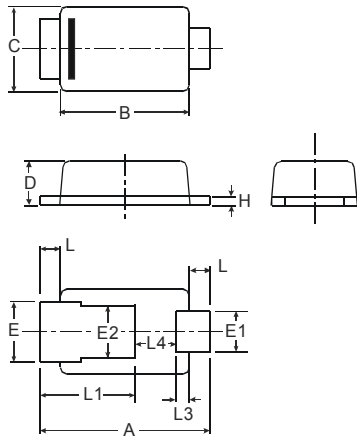


Figure 6 Operating Temperature Derating

Package Outline Dimensions

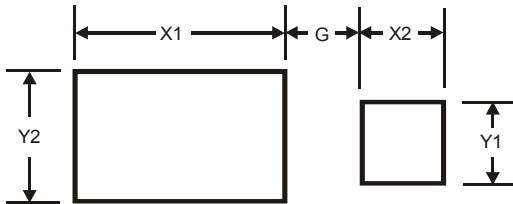
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



POWERDI323			
Dim	Min	Max	Typ
A	2.40	2.60	2.50
B	1.85	1.95	1.90
C	1.20	1.30	1.25
D	0.60	0.70	0.65
E	0.78	0.98	0.88
E1	0.50	0.70	0.60
E2	0.60	1.00	0.80
H	0.08	0.18	0.13
L	0.20	0.40	0.30
L1	—	—	1.40
L3	—	—	0.20
L4	0.40	0.80	0.60
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
G	0.5
X1	2.0
X2	0.8
Y1	0.8
Y2	1.1

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